

#### SURFACE MOUNT GLASS PASSIVATED STANDARD RECTIFIER BRIDGE

VOLTAGE RANGE

CURRENT

DB201S	THRU	DB207S
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#### Features

- Glass passivated chip
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High temperature soldering: 260 °C/10S at terminals
- Component in accordance to ROHS 2002/95/1 and WEEE 2002/96/EC

#### Mechanical Data

- Case: Molded plastic body
- Molding compound meets UL 94 V-0 flammability rating, Halogen-free, RoHS-compliant, and commercial grade
- Polarity: Molded on body
- Weight: 0.02 ounce, 0.40 grams

### Maximum Ratings and Electrical Characteristics

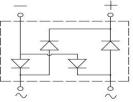
- Ratings at  $25\,^\circ\!\!\!C$  ambient temperature unless otherwise specified
- Single Phase, half wave, 60Hz, resistive or inductive load
- For capacitive load derate current by 20%

TYPE NUMBER		SYMB OLS	DB 201S	DB 202S	DB 203S	DB 204S	DB 205S	DB 206S	DB 207S	UNITS
Maximum Repetitive Peak Reverse Voltag	е	V <sub>RRM</sub>	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage		V <sub>RMS</sub>	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage		V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Curr	ent T∟=100°C	I <sub>(AV)</sub>	2.0					Amp		
Peak Forward Surge Current 8.3mS single half sine wave superimposed on rated load (JEDEC method)		IFSM	60				Amps			
Maximum Instantaneous Forward Voltage @ 2.0A		VF	1.1				Volts			
Rating for Fusing (t<8.3ms)		l²t	14.95				A <sup>2</sup> s			
Maximum DC Reverse Current at Rated	T <sub>A</sub> = 25℃	_	5.0							
DC Blocking Voltage	T <sub>A</sub> = 125℃	IR				100				μA
Typical Junction Capacitance (Note 1)		CJ	30				pF			
Typical Thermal Resistance (Note 2)		R <sub>0JA</sub>	40				°C 144			
		R <sub>0JL</sub>	15				°C/W			
Operating Junction Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	G (-55 to +150)				°C			

Notes:

- 1. Measured at 1.0MHz and applied reverse voltage of 4.0 Volts.
- 2. Thermal Resistance test performed in accordance with JESD-51. Unit mounted on 15mm\*12mm\*1.6mm AL pad attach 195mm\*110mm\*10mm steel plate.
- 3. The typical data above is for reference only.





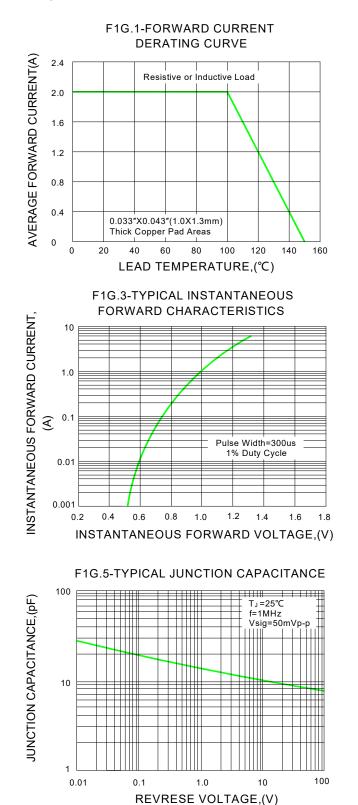
RoHS



## VOLTAGE RANGE

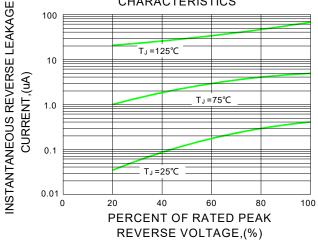
50 to 1000 Volts 2.0 Ampere

#### Ratings and Characteristic Curves (TA=25 °C unless otherwise noted)



F1G.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

#### F1G.4-TYPICAL REVERSE CHARACTERISTICS

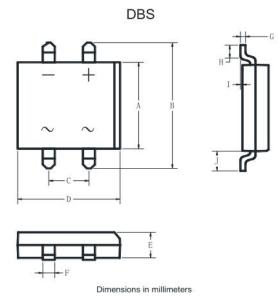




VOLTAGE RANGE	50 to 1000 Volts
CURRENT	2.0 Ampere

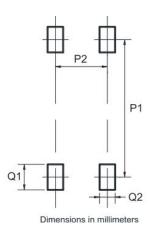
#### Package Outline Dimensions in inches (millimeters)

Outline Dimensions



Dim m		nm	in	
	min	max	min	max
А	6.20	6.50	.244	.256
В	9.60	10.30	.378	.406
С	5.00	5.20	.197	.205
D	8.13	8.51	.320	.335
Е	2.38	2.45	.093	.096
F	0.98	1.13	.038	.044
G	0.18	0.23	.007	.009
Н	1.02	1.53	.040	.060
Ι	0.05	0.20	.001	.007
J	1.80	2.10	.070	.082

• Suggested pad layout



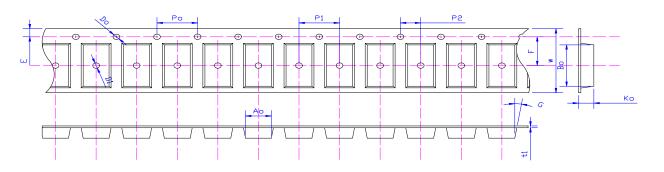
Dim	Min
P1	8.73
P2	5.12
Q1	2.22
Q2	1.2



# VOLTAGE RANGE50 to 1000 VoltsCURRENT2.0 Ampere

### **Packing Requirments**

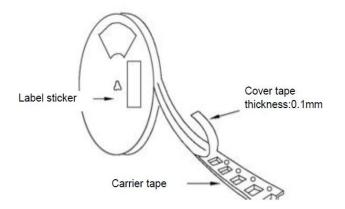
PS black anti-static carrier tape packing



Specifications	Ao	Во	Ko	Po	W	t1
DBS	8.64±0.10	9.85±0.10	2.60±0.10	4.00±0.1	16.0±0.10	0.30±0.02

13 "antistatic plastic reel

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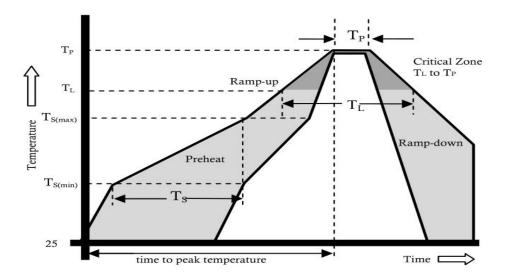


	13" Reel				
DEVICE TYPE	Q'TY/REEL(pcs)	REEL/BOX	BOX/CARTOON	Q'TY/CARTON(pcs)	
DBS	3000	2	8	48000	



VOLTAGE RANGE	50 to 1000 Volts
CURRENT	2.0 Ampere

#### **Reflow Profile**



	Reflow Condition	Pb-Free Assembly	
Temperature Min.		+150°C	
Pre Heat	Temperature Max.	+200°C	
	Time(Min to Max)	60-180 secs.	
Average ram	p up rate(Liquidus Temp(T∟) to peak)	3°C/sec. Max.	
T <sub>s</sub> (max) to T <sub>L</sub> - Ramp-up Rate		3°C/sec. Max.	
Reflow	Temperature (T∟)(Liquidus)	+217°C	
Reliow	Temperature (T∟)	60-150 secs.	
Peak Temp (T <sub>P</sub> )		+(260+0/-5 )°C	
Time within 5°C of actual Peak Temp (T <sub>P</sub> )		25 secs.	
Ramp-down Rate		6°C/sec. Max.	
Tin	ne 25°C to peak Temp (T⊦)	8 min. Max.	
Do not exceed		+260°C	



VOLTAGE RANGE50 to 1000 VoltsCURRENT2.0 Ampere

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